



Interface Transceiver of RS-232 Standard with One Supply Voltage

(compatible to MAX3232 (MAXIM USA))

DESCRIPTION

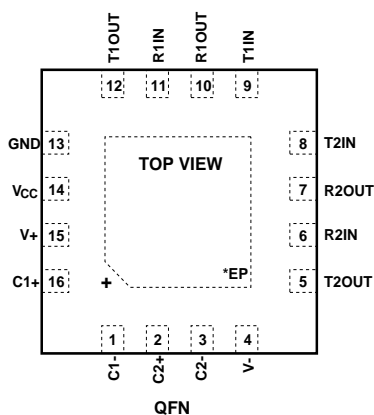
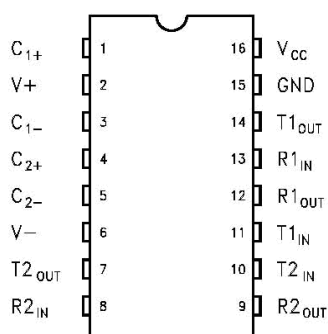
The HT3232 is a 3.3V powered EIA/TIA-232 and V.28/V.24 communication interface with low power requirements, high data-rate capabilities. HT3232 has a proprietary low dropout transmitter output stage providing true RS-232 performance from 3.3V to 5.5V supplies. The device requires only four small 0.1 μ F standard external capacitors for operations from 3.3V supply.

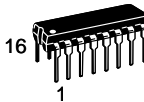
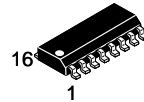
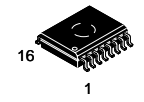
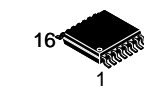
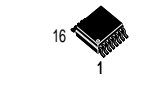
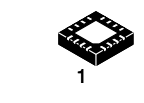
The HT3232 has two receivers and two drivers. The device is guaranteed to run at data rates of 120Kbps while maintaining RS-232 output levels. Typical applications are Notebook, Subnotebook and Palmtop Computers, Battery Powered Equipment, Hand-Held Equipment, Peripherals and Printers.

FEATURES

- 300 μ A SUPPLY CURRENT
- 120Kbps MAX GUARENTEED DATA RATE
- 3V/ μ s MINIMUM GUARANTEED SLEW RATE
- ENHANCED ESD SPECIFICATIONS:
 - ± 15 kV IEC61000-4-2 Air Discharge
 - ± 8 kV IEC61000-4-2 Contact Discharge

PIN CONFIGURATION



| | |
|--|---|
|  | DIP16 N SUFFIX HT3232EENZ |
|  | SOP16 R SUFFIX HT3232EERZ |
|  | WSOP16 W SUFFIX HT3232EERWZ |
|  | TSSOP16 T SUFFIX HT3232EERTZ |
|  | SSOP16 S SUFFIX HT3232EERSZ |
|  | QFN16-4*4 Q SUFFIX HT3232EERQZ |

$T_A =$ from -40 to 125 $^{\circ}$ C For all packages

PIN DESCRIPTION

| PIN N° | SYMBOL | NAME AND FUNCTION |
|--------|--------|--|
| 1 | C1+ | Positive Terminal for the first Charge Pump Capacitor |
| 2 | V+ | Doubled Voltage Terminal |
| 3 | C1 | Negative Terminal for the first Charge Pump Capacitor |
| 4 | C2+ | Positive Terminal for the second Charge Pump Capacitor |
| 5 | C2 | Negative Terminal for the second Charge Pump Capacitor |
| 6 | V- | Inverted Voltage Terminal |
| 7 | T2OUT | Second Transmitter Output Voltage |
| 8 | R2IN | Second Receiver Input Voltage |
| 9 | R2OUT | Second Receiver Output Voltage |
| 10 | T2IN | Second Transmitter Input Voltage |
| 11 | T1IN | First Transmitter Input Voltage |
| 12 | R1OUT | First Receiver Output Voltage |
| 13 | R1IN | First Receiver Input Voltage |
| 14 | T1OUT | First Transmitter Output Voltage |
| 15 | GND | Ground |
| 16 | VCC | Supply Voltage |

ABSOLUTE MAXIMUM RATING

| Symbol | Parameter | Value | Unit |
|---------|--------------------------------------|---------------------|------|
| VCC | Supply Voltage | -0.3 to 6 | V |
| V+ | Doubled Voltage Terminal | (VCC - 0.3) to 7 | V |
| V- | Inverted Voltage Terminal | 0.3 to -7 | V |
| V+ + V- | | 13 | V |
| TIN | Transmitter Input Voltage Range | -0.3 to 6 | V |
| RIN | Receiver Input Voltage Range | ± 25 | V |
| TOUT | Transmitter Output Voltage Range | ± 13.2 | V |
| ROUT | Receiver Output Voltage Range | -0.3 to (VCC + 0.3) | V |
| Ts | Storage Temperature | -60 to 150 | °C |
| tSHORT | Transmitter Output Short to GND Time | Continuous | |

* Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied.

Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. V+ and V-can have a maximum magnitude of +7V, but their absolute addition cannot exceed 13 V.

ELECTRICAL CHARACTERISTICS

($C_1 - C_4 = 0.1\mu\text{F}$, $V_{CC} = 3.3\text{V}$ to 5.5V , $T_A = -40$ to 85°C , unless otherwise specified.)

Typical values are referred to $T_A = 25^\circ\text{C}$)

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|---------------------|--------------------------|--|------|------|------|------|
| I _{SUPPLY} | VCC Power Supply Current | No Load $V_{CC} = 3.3\text{V} \pm 10\%$ $T_A = 25^\circ\text{C}$ | | 2.5 | 5 | mA |
| | | No Load $V_{CC} = 5\text{V} \pm 10\%$ $T_A = 25^\circ\text{C}$ | | 6 | 10 | mA |

LOGIC INPUT ELECTRICAL CHARACTERISTICS

($C_1 - C_4 = 0.1\mu\text{F}$, $V_{CC} = 3.3\text{V}$ to 5.5V , $T_A = -40$ to 85°C , unless otherwise specified.)

Typical values are referred to $T_A = 25^\circ\text{C}$)

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|------------------|----------------------------|------------------------|------|------------|---------|---------------|
| V _{TIL} | Input Logic Threshold Low | T-IN (Note 1) | | | 0.8 | V |
| V _{TIH} | Input Logic Threshold High | $V_{CC} = 3.3\text{V}$ | 2 | | | V |
| | | $V_{CC} = 5\text{V}$ | 2.4 | | | V |
| I _{IL} | Input Leakage Current | T-IN | | ± 0.01 | ± 1 | μA |

Note1: Transmitter input hysteresis is typically 250mV

TRANSMITTER ELECTRICAL CHARACTERISTICS

($C_1 - C_4 = 0.1\mu\text{F}$ tested at $V_{CC} = 3.3\text{V}$ to 5.5V , $T_A = -40$ to 85°C , unless otherwise specified.)

Typical values are referred to $T_A = 25^\circ\text{C}$)

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit | |
|-------------------|-------------------------------|--|------------------------|-----------|-----------|----------|---|
| V _{TOUT} | Output Voltage Swing | All Transmitter outputs are loaded with $3\text{k}\Omega$ to GND | $V_{CC} = 5.0\text{V}$ | ± 5 | ± 5.4 | | V |
| | | | $V_{CC} = 3.3\text{V}$ | ± 3.5 | ± 4.0 | | |
| R _{TOUT} | Transmitter Output Resistance | $V_{CC} = V+ = V- = 0\text{V}$ $V_{OUT} = \pm 2\text{V}$ | 300 | 10M | | Ω | |
| I _{TSC} | Output Short Circuit Current | $V_{CC} = 3.3\text{V}$ to 5V $V_{OUT} = 0\text{V}$ | | | ± 60 | mA | |

RECEIVER ELECTRICAL CHARACTERISTICS

($C_1 - C_4 = 0.1\mu\text{F}$ tested at $V_{CC} = 3.3\text{V}$ to 5.5V , $T_A = -40$ to 85°C , unless otherwise specified.)

Typical values are referred to $T_A = 25^\circ\text{C}$)

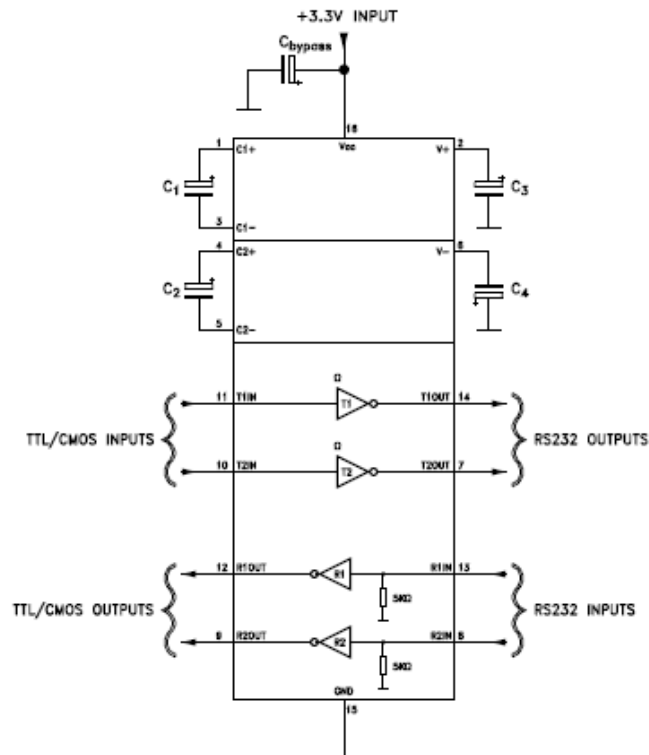
| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|--------------------|--|--|----------------------|----------------------|------|------------|
| V _{RIN} | Receiver Input Voltage Operating Range | | -25 | | 25 | V |
| V _{RIL} | RS-232 Input Threshold Low | $T_A = 25^\circ\text{C}$ $V_{CC} = 3.3\text{V}$ | 0.6 | 1.2 | | V |
| | | $T_A = 25^\circ\text{C}$ $V_{CC} = 5\text{V}$ | 0.8 | 1.5 | | V |
| V _{RIH} | RS-232 Input Threshold High | $T_A = 25^\circ\text{C}$ $V_{CC} = 3.3\text{V}$ | | 1.5 | 2.4 | V |
| | | $T_A = 25^\circ\text{C}$ $V_{CC} = 5\text{V}$ | | 1.8 | 2.4 | V |
| V _{RIHYS} | Input Hysteresis | | | 0.3 | | V |
| R _{RIN} | Input Resistance | $T_A = 25^\circ\text{C}$ | 3 | 5 | 7 | k Ω |
| V _{ROL} | TTL/CMOS Output Voltage Low | I _{OUT} = 1.6mA $V_{CC} = 3.3\text{V}$ | | | 0.4 | V |
| | | I _{OUT} = 3.2mA $V_{CC} = 5.5\text{V}$ | | | | |
| V _{ROH} | TTL/CMOS Output Voltage High | I _{OUT} = -0.5mA $V_{CC} = 3.3\text{V}$ | V _{CC} -0.6 | V _{CC} -0.1 | | V |
| | | I _{OUT} = -1mA $V_{CC} = 5.5\text{V}$ | | | | |

TIMING CHARACTERISTICS

($C_1 - C_4 = 0.1\mu\text{F}$, $V_{CC} = 3.3\text{V}$ to 5.5V , $T_A = -40$ to 85°C , unless otherwise specified.
 Typical values are referred to $T_A = 25^\circ\text{C}$)

| Symbol | Parameter | Test Conditions | | Min. | Typ. | Max. | Unit |
|--------------------------|--|---|---|------|------|------|------------------------|
| D_R | Data Transfer Rate | $R_L = 3\text{K}\Omega$ | $C_{L2} = 1000\text{pF}$ one transmitter switching | | | 120 | Kbps |
| t_{PHLR} t_{PLHR} | Propagation Delay Input to Output | $R_{XIN} = R_{XOUT}$ | $C_L = 150\text{pF}$ | | 4.0 | 9.7 | μs |
| t_{PHLT} t_{PLHT} | Propagation Delay Input to Output | $R_L = 3\text{K}\Omega$ | $C_L = 2500\text{pF}$ | | 2.0 | 5.0 | μs |
| $ t_{PHLR} - t_{PLHR} $ | Receiver Propagation Delay Difference | | | | 300 | | ns |
| $ t_{PHLT} - t_{PLHT} $ | Transmitter Propagation Delay Difference | | | | 300 | | ns |
| S_{RT} | Transition Slew Rate | $T_A = 25^\circ\text{C}$ $R_L = 3\text{K}\Omega$ to $7\text{K}\Omega$ $V_{CC} = 3.3\text{V}$ measured from $+3\text{V}$ to -3V or -3V to $+3\text{V}$ $C_L = 150\text{pF}$ to 1000pF | | 3 | | 30 | $\text{V}/\mu\text{s}$ |

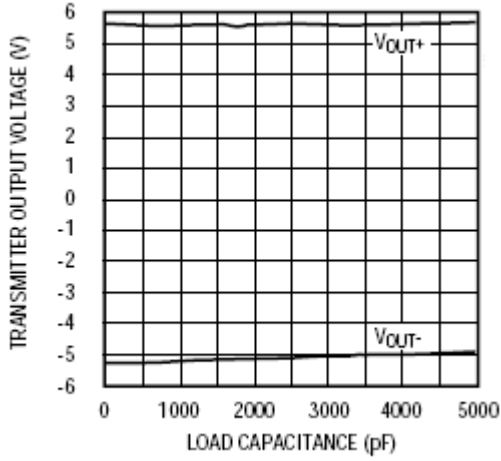
Transmitter Skew is measured at the transmitter zero cross points

APPLICATION CIRCUITS

CAPACITANCE VALUE (μF)

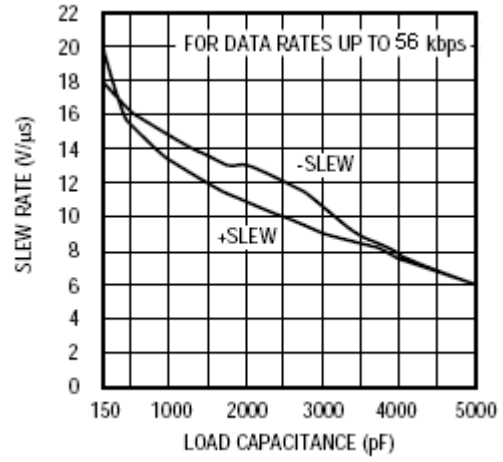
| V_{CC} | C1 | C2 | C3 | C4 | C_bypass |
|------------|-----|-----|-----|-----|----------|
| 3.0 to 5.5 | 1.0 | 1.0 | 1.0 | 1.0 | 1.0 |

TYPICAL OPERATING CHARACTERISTICS

(VCC = +3.3V, 120kbps data rate, 0.1μF capacitors, all transmitters loaded with 3kΩ, TA = +25°C, unless otherwise noted.)



**TRANSMITTER OUTPUT VOLTAGE
vs. LOAD CAPACITANCE**



**SLEW RATE
vs. LOAD CAPACITANCE**

ESD PROTECTION

The HT3232 incorporates ruggedized ESD cells on all driver output and receiver input pins. The ESD structure is for rugged applications and environments sensitive to electro-static discharges and associated transients. The ESD tolerance is at least $\pm 15\text{kV}$ without damage or latch-up.

There are different methods of ESD testing applied:

- a) MIL-STD-883, Method 3015.7
- b) IEC1000-4-2 Air-Discharge

The Human Body Model has been the generally accepted ESD testing method for semiconductors. This method is also specified in MIL-STD- 883, Method 3015.7 for ESD testing. The premise of this ESD test is to simulate the human body's potential to store electro-static energy and discharge it to an integrated circuit. The simulation is performed by using a test model as shown in *Figure 1*. This method will test the IC's capability to withstand an ESD transient during normal handling such as in manufacturing areas where the ICs tend to be handled frequently.

The IEC-1000-4-2, formerly IEC801-2, is generally used for testing ESD on equipment and systems. For system manufacturers, they must guarantee a certain amount of ESD protection since the system itself is exposed to the outside environment and human presence. The premise with IEC1000-4-2 is that the system is required to withstand an amount of static electricity when ESD is applied to points and surfaces of the equipment that are accessible to personnel during normal usage. The transceiver IC receives most of the ESD current when the ESD source is applied to the connector pins. The test circuit for IEC1000-4-2 is shown on *Figure 2*. There are two methods within IEC1000-4-2, the Air Discharge method and the Contact Discharge method.

With the Air Discharge Method, an ESD voltage is applied to the equipment under test (EUT) through air. This simulates an electrically charged person ready to connect a cable onto the rear of the system only to find an unpleasant zap just before the person touches the back panel. The high energy potential on the person discharges through an arcing path to the rear panel of the system before he or she even touches the system. This energy, whether discharged directly or through air, is predominantly a function of the discharge current rather than the discharge voltage. Variables with an air discharge such as approach speed of the object carrying the ESD potential to the system and humidity will tend to change the discharge current. For example, the rise time of the discharge current varies with the approach speed.

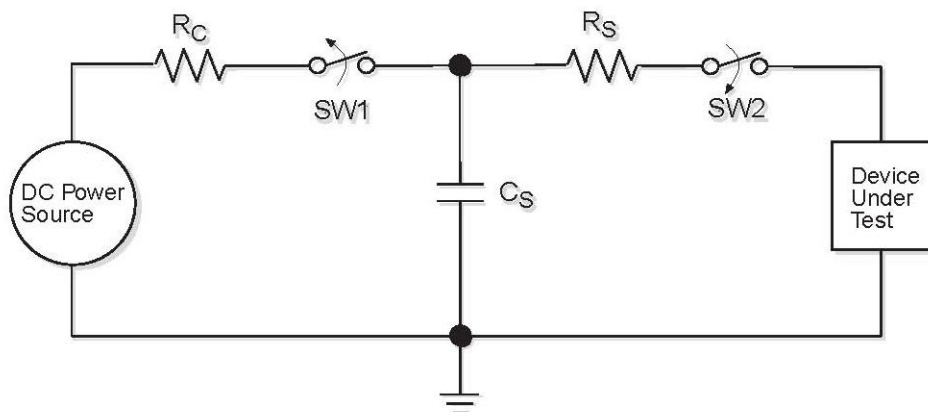


Fig. 1 ESD Test Circuit for Human Body Model

The Contact Discharge Method applies the ESD current directly to the EUT. This method was devised to reduce the unpredictability of the ESD arc. The discharge current rise time is constant since the energy is directly transferred without the air-gap arc. In situations such as hand held systems, the ESD charge can be directly discharged to the equipment from a person already holding the equipment. The current is transferred on to the keypad or the serial port of the equipment directly and then travels through the PCB and finally to the IC.

The circuit models in *Figures 1 and 2* represent the typical ESD testing circuits used for these methods. The CS is initially charged with the DC power supply when the first switch (SW1) is on. Now that the capacitor is charged, the second switch (SW2) is on while SW1 switches off. The voltage stored in the capacitor is then applied through RS, the current limiting resistor, onto the device under test (DUT). In ESD tests, the SW2 switch is pulsed so that the device under test receives a duration of voltage.

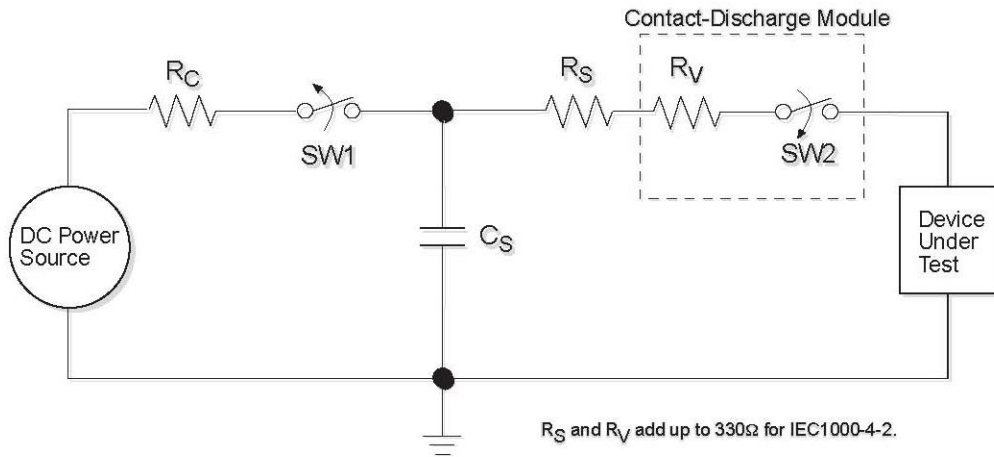


Fig. 2. ESD Test Circuit for IEC1000-4-2

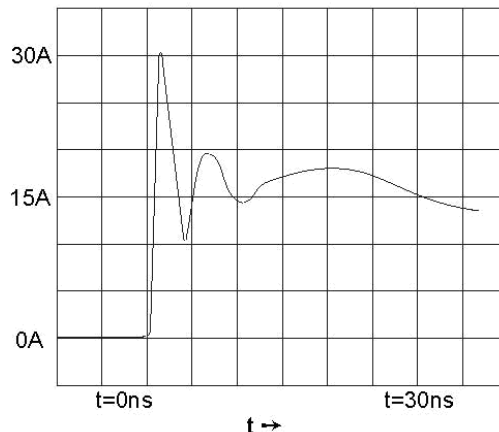
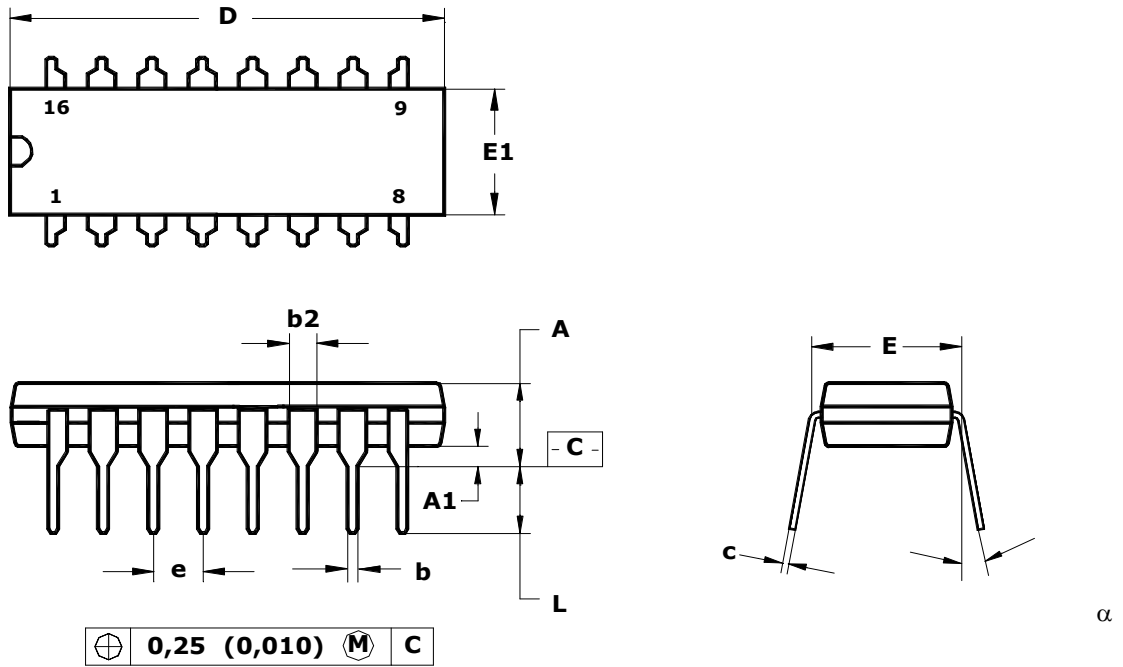


Fig. 3. ESD Test Waveform for IEC1000-4-2

For the Human Body Model, the current limiting resistor (R_s) and the source capacitor (C_s) are $1.5k\Omega$ and $100pF$, respectively. For IEC-1000-4-2, the current limiting resistor (R_s) and the source capacitor (C_s) are 330Ω and $150pF$, respectively. The higher C_s value and lower R_s value in the IEC1000-4-2 model are more stringent than the Human Body Model. The larger storage capacitor injects a higher voltage to the test point when SW2 is switched on. The lower current limiting resistor increases the current charge onto the test point.

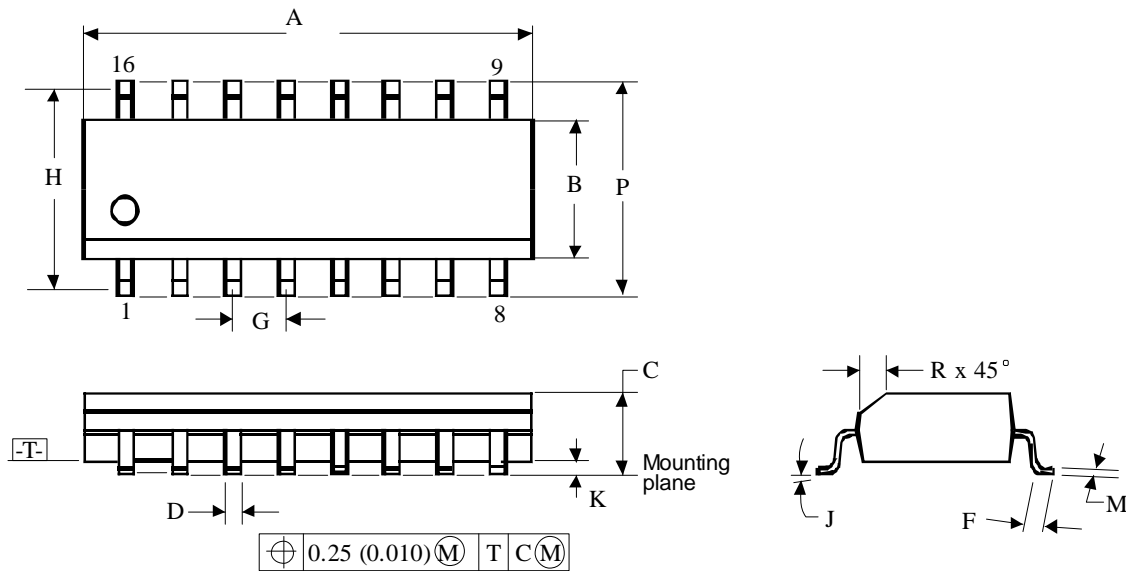
| Device Pin Tested | IEC1000-4-2 | |
|-------------------|---------------|-------|
| | Air Discharge | Level |
| Driver Outputs | $\pm 15kV$ | 4 |
| Receiver Inputs | $\pm 15kV$ | 4 |

Package Dimensions
DIP16

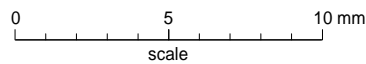
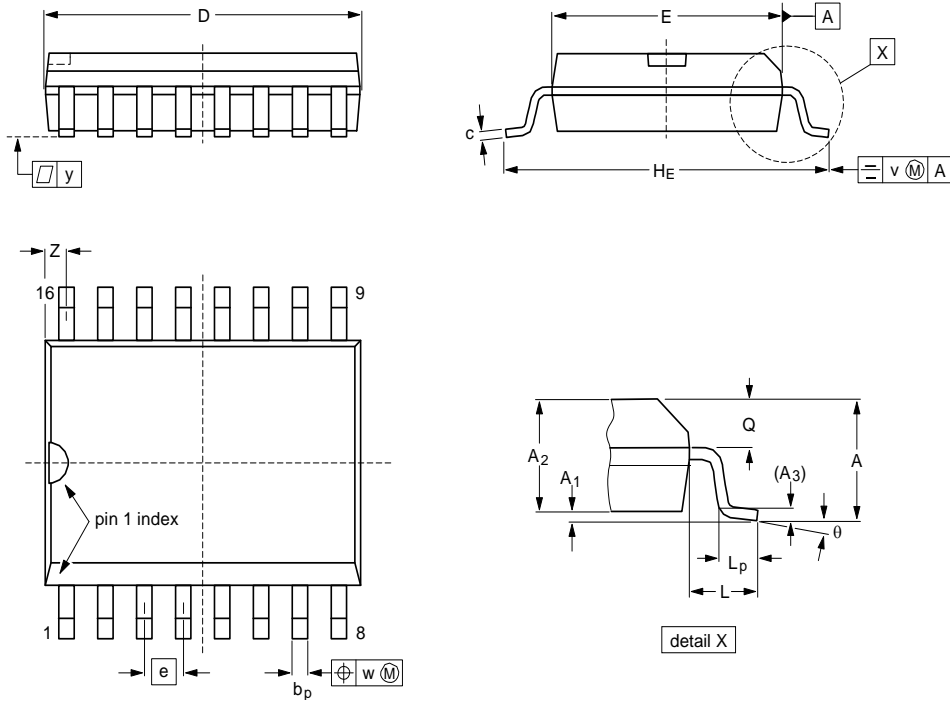


Note - Dimensions D, E1 do not include the fin value, which should not exceed 0.25 mm (0.010) per side.

| | D | E1 | A | b | b2 | e | α | L | E | c | A1 |
|--------|-------|-------|-------|-------|-------|------|----------|-------|-------|-------|-------|
| mm | | | | | | | | | | | |
| min | 18.93 | 6.07 | — | 0.36 | 1.14 | 2.54 | 0° | 2.93 | 7.62 | 0.20 | 0.38 |
| max | 19.43 | 7.11 | 5.33 | 0.56 | 1.78 | | 15° | 3.81 | 8.26 | 0.36 | — |
| Inches | | | | | | | | | | | |
| min | 0.355 | 0.240 | — | 0.014 | 0.045 | 0.1 | 0° | 0.115 | 0.300 | 0.008 | 0.015 |
| max | 0.400 | 0.280 | 0.210 | 0.022 | 0.070 | | 15° | 0.150 | 0.325 | 0.014 | — |

Package Dimensions
SOP16


| Note: | Identifi- cation | Sizes, mm | |
|---|---------------------|-----------|------|
| | | MIN | MAX |
| 1. Dimensional sizes A and B are preset without consideration of fin and the metal bulges. 2. Availability of the fin and the metal bulges for A – up to 0.15 mm (0.006) per side; for B – up to 0.25 mm (0.010) per side. | A | 9.80 | 10.0 |
| | B | 3.80 | 4.00 |
| | C | 1.35 | 1.75 |
| | D | 0.33 | 0.51 |
| | F | 0.40 | 1.27 |
| | G | 1.27 | |
| | H | 5.72 | |
| | J | 0° | 8° |
| | K | 0.10 | 0.25 |
| | M | 0.19 | 0.25 |
| | P | 5.80 | 6.20 |
| | R | 0.25 | 0.50 |

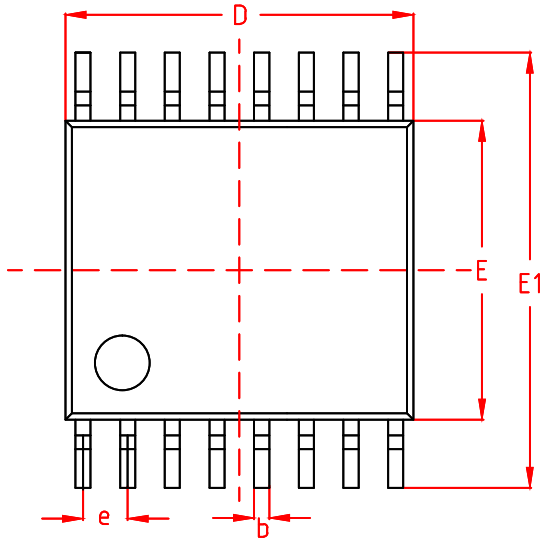
WSOP16: plastic small outline package; 16 leads; body width 7.5 mm

DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT | A max. | A ₁ | A ₂ | A ₃ | b _p | c | D ⁽¹⁾ | E ⁽¹⁾ | e | H _E | L | L _p | Q | v | w | y | Z ⁽¹⁾ | θ |
|--------|-----------|----------------|----------------|----------------|----------------|----------------|------------------|------------------|-------|----------------|-------|----------------|----------------|------|------|-------|------------------|----------|
| mm | 2.65 | 0.30 0.10 | 2.45 2.25 | 0.25 | 0.49 0.36 | 0.32 0.23 | 10.5 10.1 | 7.6 7.4 | 1.27 | 10.65 10.00 | 1.4 | 1.1 0.4 | 1.1 1.0 | 0.25 | 0.25 | 0.1 | 0.9 0.4 | 8° 0° |
| inches | 0.10 | 0.012 0.004 | 0.096 0.089 | 0.01 | 0.019 0.014 | 0.013 0.009 | 0.41 0.40 | 0.30 0.29 | 0.050 | 0.419 0.394 | 0.055 | 0.043 0.016 | 0.043 0.039 | 0.01 | 0.01 | 0.004 | 0.035 0.016 | |

TSSOP16: plastic small outline package; 16 leads; body width 4.4 mm

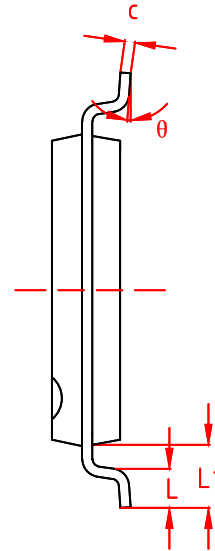
TOP VIEW

正视图



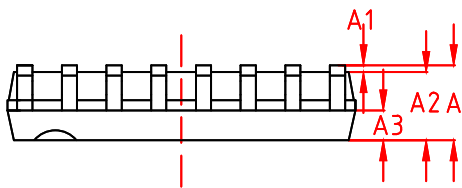
SIDE VIEW

侧视图



SIDE VIEW

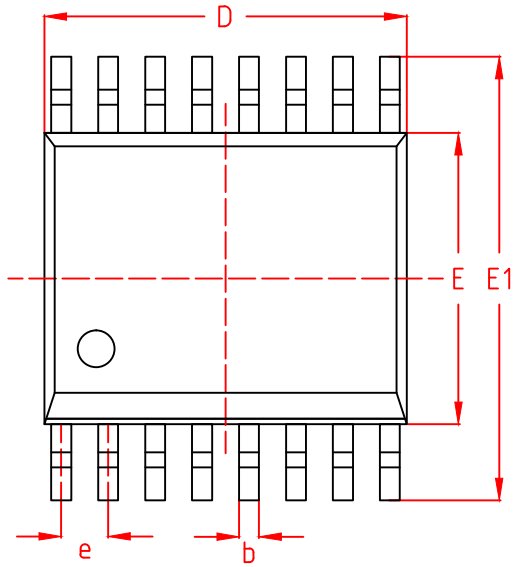
侧视图



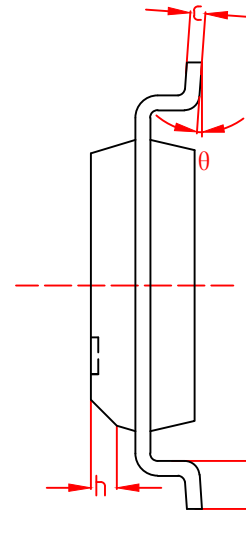
| 机械尺寸/mm Dimensions | | | |
|-----------------------|------------|----------------|------------|
| 字符 SYMBOL | 最小值 MIN | 典型值 NOMINAL | 最大值 MAX |
| A | - | - | 1.20 |
| A1 | 0.05 | - | 0.15 |
| A2 | 0.90 | 1.00 | 1.05 |
| A3 | 0.39 | 0.44 | 0.49 |
| b | 0.20 | - | 0.28 |
| c | 0.13 | - | 0.17 |
| D | 4.90 | 5.00 | 5.10 |
| E | 4.30 | 4.40 | 4.50 |
| E1 | 6.20 | 6.40 | 6.60 |
| e | 0.65 BSC | | |
| L1 | 1.00REF | | |
| L | 0.45 | 0.60 | 0.75 |
| θ | 0° | - | 8° |

SSOP16: plastic small outline package; 16 leads; body width 3.9 mm

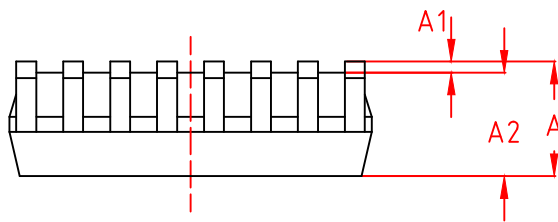
TOP VIEW
正视图



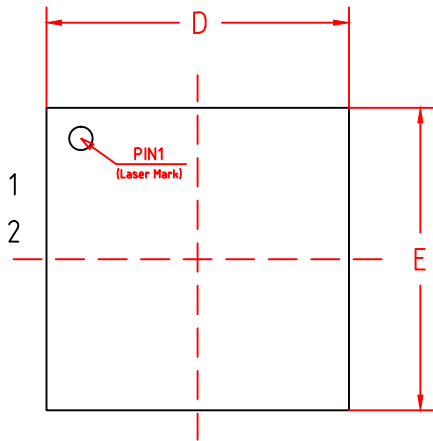
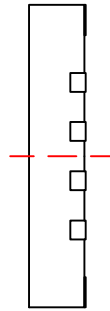
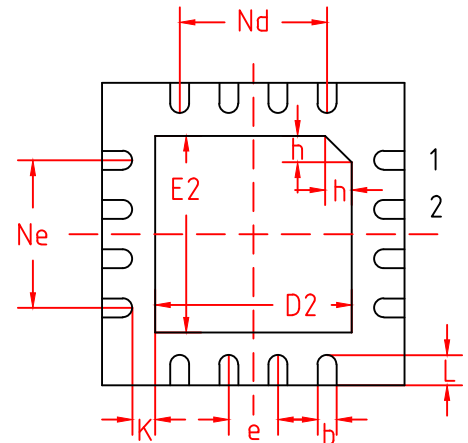
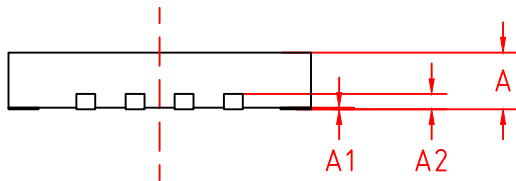
SIDE VIEW
侧视图



SIDE VIEW
侧视图



| 机械尺寸/mm Dimensions | | | |
|-----------------------|------------|----------------|------------|
| 字符 SYMBOL | 最小值 MIN | 典型值 NOMINAL | 最大值 MAX |
| A | - | - | 1.75 |
| A1 | 0.10 | 0.15 | 0.25 |
| A2 | 1.35 | 1.45 | 1.55 |
| b | 0.23 | - | 0.31 |
| c | 0.19 | - | 0.25 |
| D | 4.80 | 4.90 | 5.00 |
| E | 3.80 | 3.90 | 4.00 |
| E1 | 5.80 | 6.00 | 6.20 |
| e | 0.635 BSC | | |
| h | 0.30 | - | 0.50 |
| L | 0.50 | - | 0.80 |
| θ | 0° | - | 8° |

QFN16L(4x4X0.75-P0.65)
TOP VIEW
 正视图

SIDE VIEW
 侧视图

BOTTOM VIEW
 背视图

SIDE VIEW
 侧视图


| 机械尺寸/mm | | | |
|--------------|------------|----------------|------------|
| 字符 SYMBOL | 最小值 MIN | 典型值 NOMINAL | 最大值 MAX |
| A | 0.70 | 0.75 | 0.80 |
| A1 | - | 0.02 | 0.05 |
| A2 | 0.203 REF | | |
| b | 0.20 | 0.25 | 0.30 |
| D | 3.90 | 4.00 | 4.10 |
| D2 | 2.50 | 2.60 | 2.70 |
| E | 3.90 | 4.00 | 4.10 |
| E2 | 2.50 | 2.60 | 2.70 |
| e | 0.65 BSC | | |
| K | 0.20 | 0.30 | 0.40 |
| L | 0.30 | 0.40 | 0.50 |
| h | 0.30 | 0.35 | 0.40 |
| Ne | 1.95 BSC | | |
| Nd | 1.95 BSC | | |